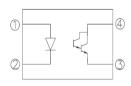


DATASHEET

4 PIN DIP PHOTODARLINGTON PHOTOCOUPLER EL815 Series



Schematic



Features:

- Compliance Halogens Free (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- Current transfer ratio (CTR: 600~7500% at I_F =1mA, V_{CE} =2V)
- High isolation voltage between input and output (Viso=5000 V rms)
- Creepage distance >7.62 mm
- Operating temperature up to +110°C
- · Compact small outline package
- •The product itself will remain within RoHS compliant version
- •Compliance with EU REACH
- UL approved (No. E214129)
- VDE approved (No. 132249)
- UL and cUL approved(No. E214129)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Description

The EL815 series of devices each consist of an infrared emitting diodes, optically coupled to a photo Darlington detector.

They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Telephone set, telephone exchangers
- Sequence controllers
- System appliances, measuring instruments
- Signal transmission between circuits of different potentials and impedances

Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector



Absolute Maximum Ratings (Ta=25℃)

	Parameter	Symbol	Rating	Unit
Input	Forward current	I _F	60	mA
	Peak forward current (1us, pulse)	I _{FP}	1	А
	Reverse voltage	V_{R}	6	V
	Power dissipation No derating required up to Ta = 100°C	P_{D}	100	mW
Output	Power dissipation	P _C —	150	mW
	Derating factor (above Ta = 80°C)		5.8	mW/°C
	Collector current	I _C	80	mA
	Collector-Emitter voltage	V _{CEO}	35	V
	Emitter-Collector voltage	V _{ECO}	7	V
Total power	dissipation	P _{TOT}	200	mW
Isolation vo	Itage *1	V_{ISO}	5000	V rms
Operating to	emperature	T _{OPR}	-55 ~ +110	°C
Storage ten	nperature	T _{STG}	-55 ~ +125	°C
Soldering T	emperature* ²	T _{SOL}	260	°C

Notes:

^{*1} AC for 1 minute, R.H.= 40 ~ 60% R.H. In this test, pins 1 & 2 are shorted together, and pins 3 & 4 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V_{F}	-	1.2	1.4	V	I _F = 20mA
Reverse Current	I_{R}	-	-	10	μA	$V_R = 4V$
Input capacitance	C_in	-	30	250	pF	V = 0, $f = 1kHz$

Output

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition	
Collector-Emitter dark	lono	_	_	1	μA	$V_{CE} = 10V, I_{F} = 0mA$	
current	I _{CEO}	_	_	'	μΛ	VCE = 10 V, IF = OHIA	
Collector-Emitter	BV_CEO	35	_	_	V	$I_{\rm C} = 0.1 \rm mA$	
breakdown voltage	D A CEO	33		_	V	IC = 0. IIIIA	
Emitter-Collector	R\/	7	_	_	V	$I_{\rm F} = 0.1 \rm mA$	
breakdown voltage	BV_{ECO}	,	-	_	V	IE – O. IIIIA	

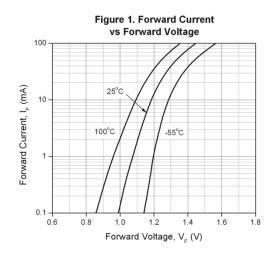
Transfer Characteristics

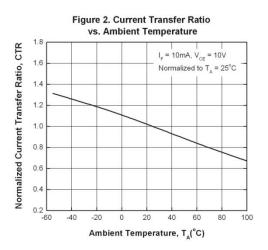
Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Current Transfer ratio	CTR	600	-	7500	%	$I_F = 1 \text{mA}$, $V_{CE} = 2 \text{V}$
Collector-Emitter saturation voltage	V _{CE(sat)}	-	0.8	1.0	V	I _F = 20mA ,I _C = 5mA
Isolation resistance	R _{IO}	5×10 ¹⁰	-	-	Ω	V _{IO} = 500Vdc, 40~60% R.H.
Floating capacitance	C_{IO}	-	0.6	1.0	pF	V _{IO} = 0, f = 1MHz
Cut-off frequency	fc	-	6	-	kHz	$V_{CE} = 5V$, $I_C = 2mA$ $R_L = 100\Omega$, -3dB
Rise time	t _r	-	60	300	μs	$V_{CE} = 2V, I_{C} = 10mA,$
Fall time	t _f	-	53	250	μs	$R_L = 100\Omega$

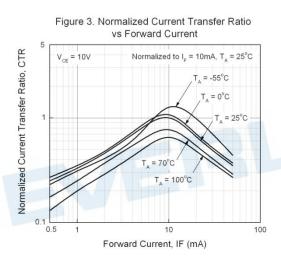
^{*} Typical values at T_a = 25°C

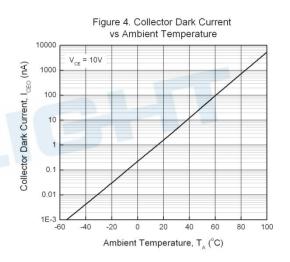


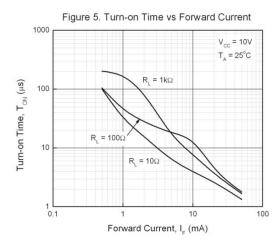
Typical Electro-Optical Characteristics Curves

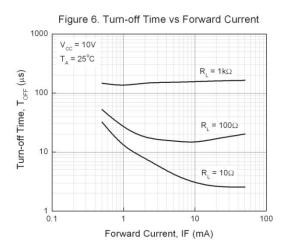














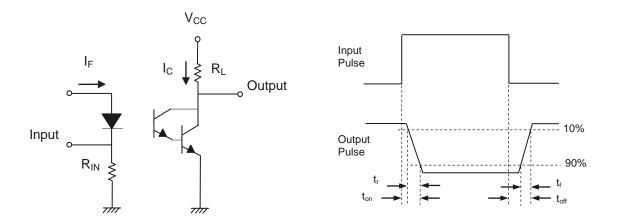


Figure 7. Switching Time Test Circuit & Waveforms





Order Information

Part Number

EL815X(Z)-V

Note

X = Lead form option (S1, M or none)

Z = Tape and reel option (TA, TB, TU, TD or none)

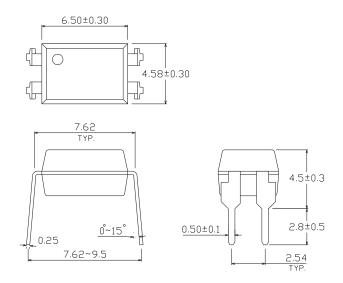
V = VDE safety (optional)

Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TA)	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 (TB)	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel

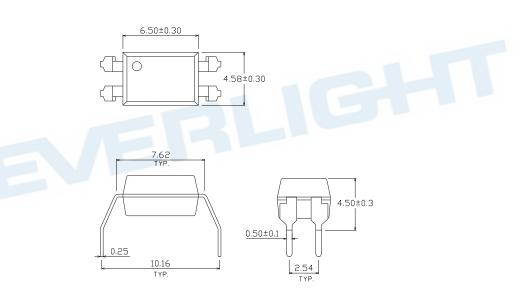


Package Dimension (Dimensions in mm)

Standard DIP Type

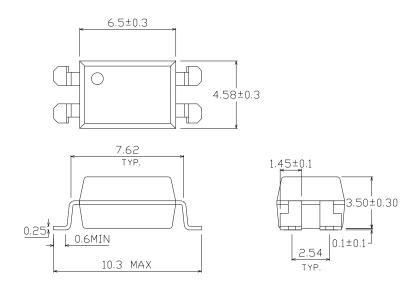


Option M Type





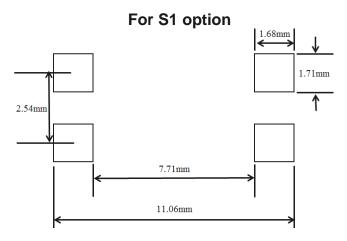
Option S1 Type







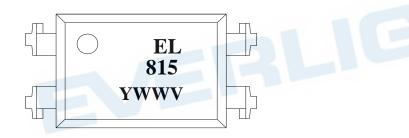
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking

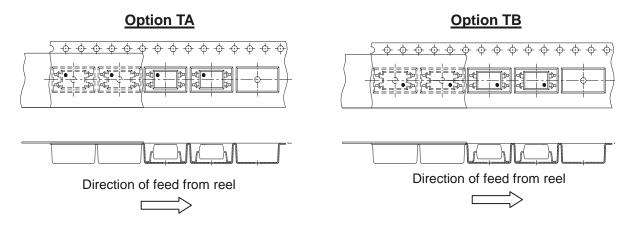


Notes

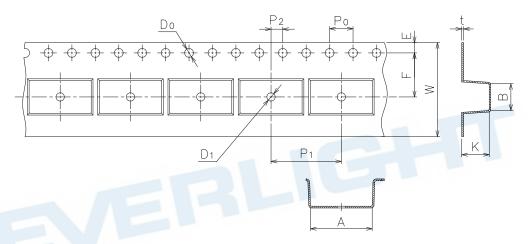
EL denotes EVERLIGHT
815 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE optional



Tape & Reel Packing Specifications



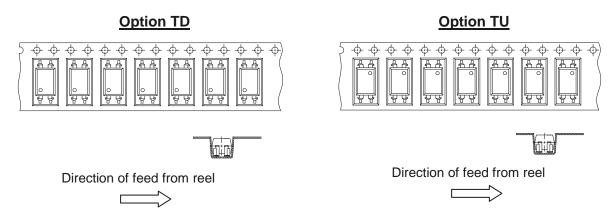
Tape dimensions



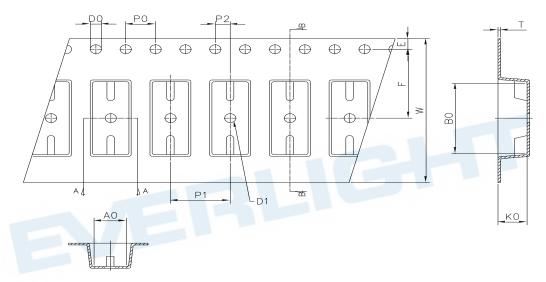
Dimension No.	Α	В	Do	D1	E	F
Dimension (mm) S1	10.7±0.1	4.65±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	W	K



Tape & Reel Packing Specifications



Tape dimensions



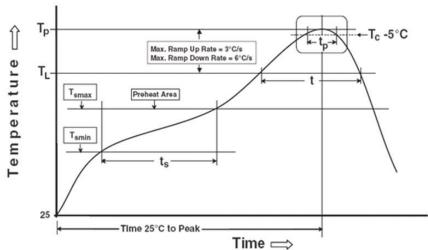
Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm)	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension (mm)	4.00±0.1	8.00±0.	2.00±0.1	0.40±0.1	16.00±0.3	4.60±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin})

Temperature max (T_{smax})

Time $(T_{smin} \text{ to } T_{smax}) (t_s)$

Average ramp-up rate (T_{smax} to T_p)

Other

Liquidus Temperature (T_L)

Time above Liquidus Temperature (t L)

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: T_P - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

Reference: IPC/JEDEC J-STD-020D

150 °C

200°C

60-120 seconds

3 °C/second max

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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